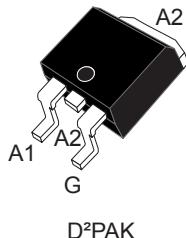
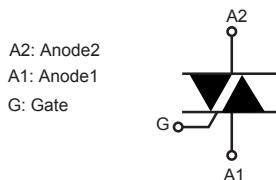


## 16 A - 800 V logic level T-series Triac in D<sup>2</sup>PAK

### Features



- 150 °C maximum junction temperature
- Three quadrants
- High commutation on resistive loads
- Surge capability  $V_{DSM}$ ,  $V_{RSM} = 900$  V
- Benefits:
  - Easy direct control by MCU thanks to low 10 mA  $I_{GT}$
  - Increase of thermal margin due to extended working  $T_j$  up to 150 °C



### Applications

- General purpose AC line load switching
- Small home appliances with resistive loads
- Hybrid relays
- Inrush current limiting circuits
- Overvoltage crowbar protection



### Description

The SMD T1610T-8G Triac can be used for the on/off or phase angle control function in general purpose AC switching with resistive loads. A Logic level T-series Triac, the T1610T-8G can be controlled directly from an MCU with a simplified circuit. T-series triacs are optimized for high EMI constraints.

The surface mount D<sup>2</sup>PAK package enables compact SMT designs for automated manufacturing.

D<sup>2</sup>PAK package's molding compound resin is halogen-free and meets UL94 flammability standard level V0.

Package environmentally friendly Ecopack2 graded (RoHS and Halogen Free compliance).

Product status link	
T1610T-8G	
Product summary	
$I_{T(RMS)}$	16 A
$V_{DRM}/V_{RRM}$	800 V
$V_{DSM}/V_{RSM}$	900 V
$I_{GT}$	10 mA

## 1 Characteristics

**Table 1. Absolute maximum ratings (limiting values),  $T_j = 25^\circ\text{C}$  unless otherwise specified**

Symbol	Parameter	Value	Unit
$V_{DRM}/V_{RRM}$	$T_j = 125^\circ\text{C}$	800	V
	$T_j = 150^\circ\text{C}$	600	V
$V_{DSM}/V_{RSM}$	$t_p = 10 \text{ ms}, T_j = 25^\circ\text{C}$	900	V
$I_T(\text{RMS})$	$T_c = 126^\circ\text{C}$	16	A
$I_{TSM}$	$t = 16.7 \text{ ms}$	126	A
	$t = 20 \text{ ms}$	120	
$I^2t$	$t_p = 10 \text{ ms}$	95	$\text{A}^2\text{s}$
$dI/dt$	$f = 100 \text{ Hz}$	100	$\text{A}/\mu\text{s}$
$I_{GM}$	$t_p = 20 \mu\text{s}, T_j = 150^\circ\text{C}$	4	A
$V_{GM}$		5	V
$P_{G(AV)}$	$T_j = 150^\circ\text{C}$	1	W
$T_{stg}$		-40 to +150	$^\circ\text{C}$
$T_j$		-40 to +150	$^\circ\text{C}$

**Table 2. Electrical characteristics ( $T_j = 25^\circ\text{C}$ , unless otherwise specified)**

Symbol	Test conditions	Quadrants; $T_j$		Value	Unit	
$I_{GT}^{(1)}$	$V_D = 12 \text{ V}, R_L = 30 \Omega$	I - II - III	Max.	10	mA	
$V_{GT}$	$V_D = 12 \text{ V}, R_L = 30 \Omega$	I - II - III	Max.	1.3	V	
$V_{GD}$	$V_D = 800 \text{ V}, R_L = 3.3 \text{ k}\Omega$	$T_j = 125^\circ\text{C}$	I - II - III	Min.	0.2	V
$I_L$	$I_G = 1.2 \times I_{GT}$	I - III	Max.	20	mA	
	$I_G = 1.2 \times I_{GT}$	II	Max.	30	mA	
$I_H^{(2)}$	$I_T = 500 \text{ mA}, \text{gate open}$		Max.	25	mA	
$dV/dt^{(2)}$	$V_D = 536 \text{ V}, \text{gate open}$	$T_j = 125^\circ\text{C}$	Min.	100	$\text{V}/\mu\text{s}$	
	$V_D = 402 \text{ V}, \text{gate open}$	$T_j = 150^\circ\text{C}$	Min.	50	$\text{V}/\mu\text{s}$	
$(dI/dt)_c^{(2)}$	$(dV/dt)_c = 0.1 \text{ V}/\mu\text{s}$	$T_j = 125^\circ\text{C}$	Min.	9	$\text{A}/\text{ms}$	
		$T_j = 150^\circ\text{C}$		5.4		
	$(dV/dt)_c = 10 \text{ V}/\mu\text{s}$	$T_j = 125^\circ\text{C}$	Min.	3	$\text{A}/\text{ms}$	
		$T_j = 150^\circ\text{C}$		1.8		

1. Minimum  $I_{GT}$  is guaranteed at 5% of  $I_{GT}$  max
2. For both polarities of A2 referenced to A1.

**Table 3. Static characteristics**

Symbol	Test conditions	T <sub>j</sub>		Value	Unit
V <sub>TM</sub> <sup>(1)</sup>	I <sub>T</sub> = 22.6 A, t <sub>p</sub> = 380 µs	25 °C	Max.	1.55	V
V <sub>TO</sub> <sup>(1)</sup>	Threshold on-state voltage	150 °C	Max.	0.85	V
R <sub>D</sub> <sup>(1)</sup>	Dynamic resistance	150 °C	Max.	34	mΩ
I <sub>DRM</sub> /I <sub>RRM</sub>	V <sub>DRM</sub> = V <sub>RRM</sub> = 800 V	25 °C	Max.	5	µA
		125°C		1.0	mA
	V <sub>DRM</sub> = V <sub>RRM</sub> = 600 V	150 °C	Max.	3.6	mA

1. For both polarities of A2 referenced to A1.

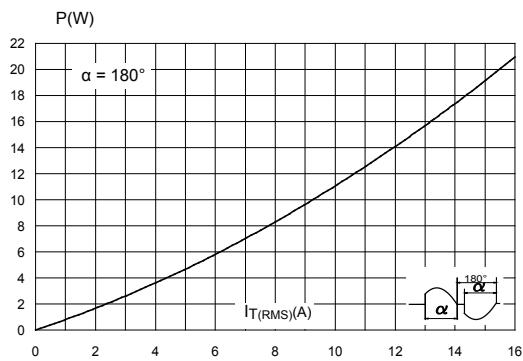
**Table 4. Thermal resistance**

Symbol	Parameter		Value	Unit
R <sub>th(j-c)</sub>	Junction to case (AC)	D <sup>2</sup> PAK	Max.	1.15 °C/W
R <sub>th(j-a)</sub>	Junction to ambient (S <sub>CU</sub> <sup>(1)</sup> = 2 cm <sup>2</sup> )		Typ.	45 °C/W

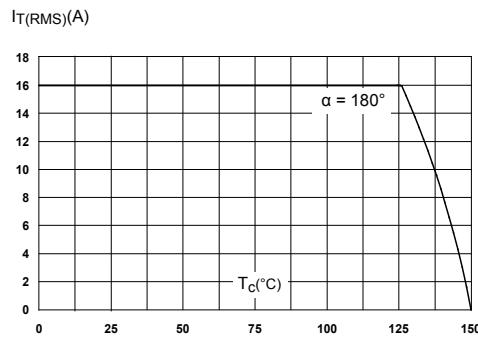
1. S<sub>CU</sub> : copper pad surface under tab, 35 µm copper thickness on FR4 PCB.

## 1.1 Characteristics (curves)

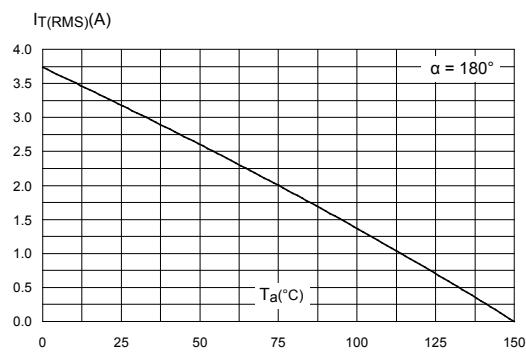
**Figure 1. Maximum power dissipation versus on-state RMS current**



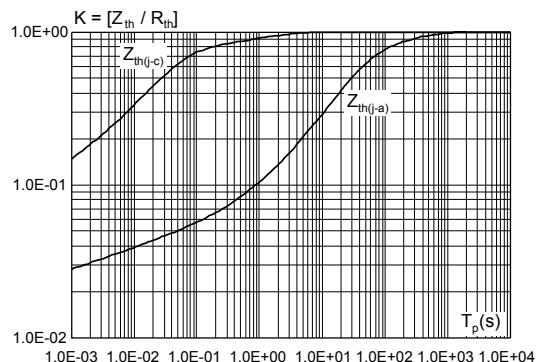
**Figure 2. On-state RMS current versus case temperature**



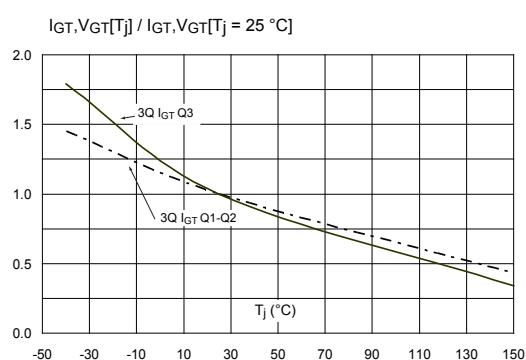
**Figure 3. On-state RMS current versus ambient temperature (free air convection)**



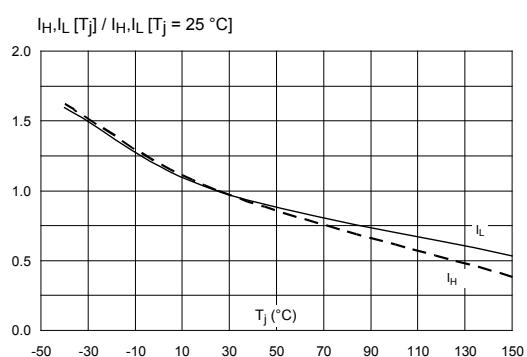
**Figure 4. Relative variation of thermal impedance versus pulse duration**



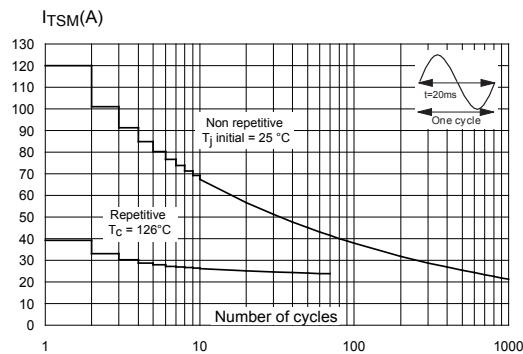
**Figure 5. Relative variation of gate trigger voltage and current versus junction temperature (typical values)**



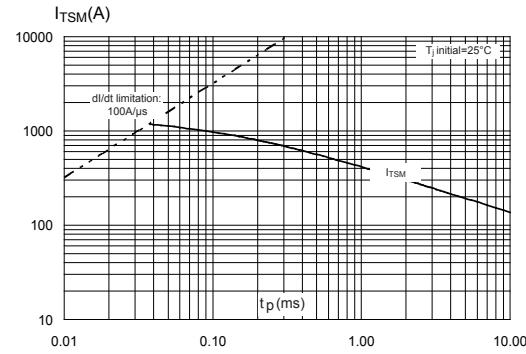
**Figure 6. Relative variation of holding current and latching current versus junction temperature (typical values)**



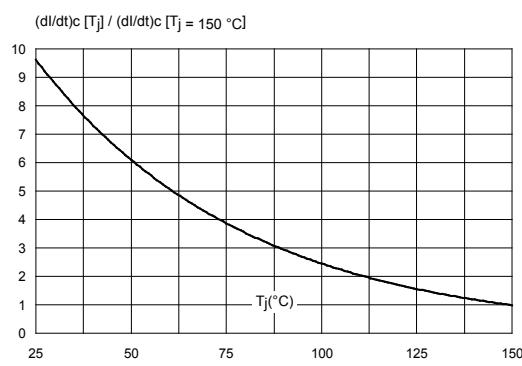
**Figure 7. Surge peak on-state current versus number of cycles**



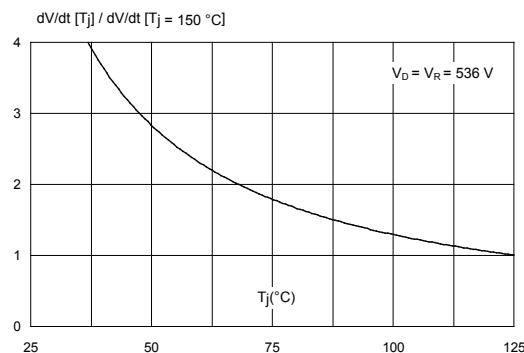
**Figure 8. Non repetitive surge peak on-state current for a sinusoidal pulse with width  $t_p < 10$  ms**



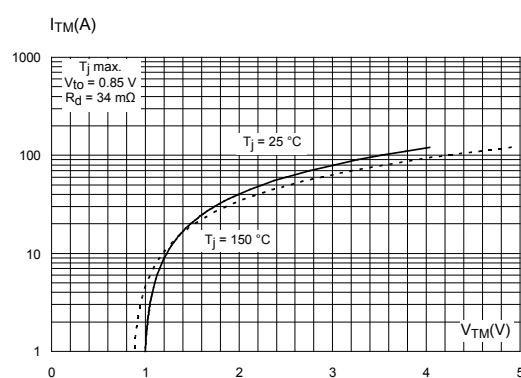
**Figure 9. Relative variation of critical rate of decrease of main current versus junction temperature (typical values)**



**Figure 10. Relative variation of critical rate of decrease of main voltage versus junction temperature**



**Figure 11. On-state characteristics (maximum values)**



**Figure 12. Relative variation of leakage current versus junction temperature for different values of blocking voltage**

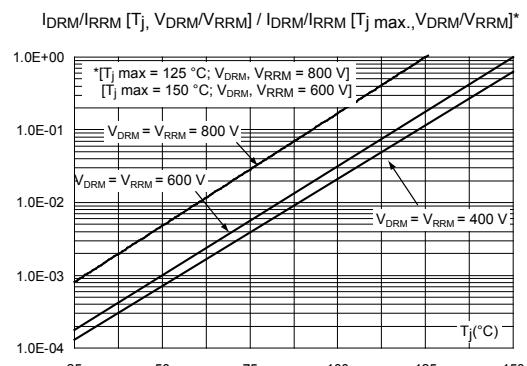
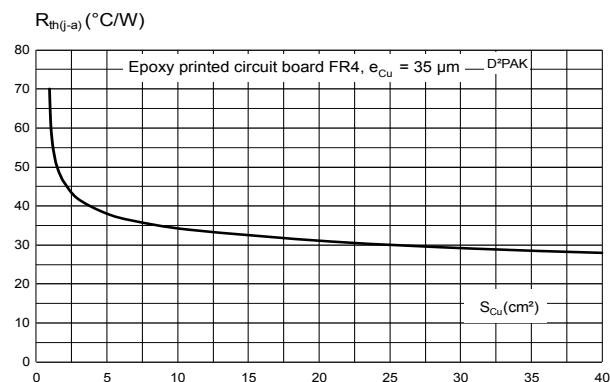


Figure 13. Thermal resistance junction to ambient versus copper surface under tab



## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 2.1 D<sup>2</sup>PAK package information

- ECOPACK2 compliant
- Lead-free package leads finishing
- Molding compound resin is halogen-free and meets UL standard level V0

Figure 14. D<sup>2</sup>PAK package outline

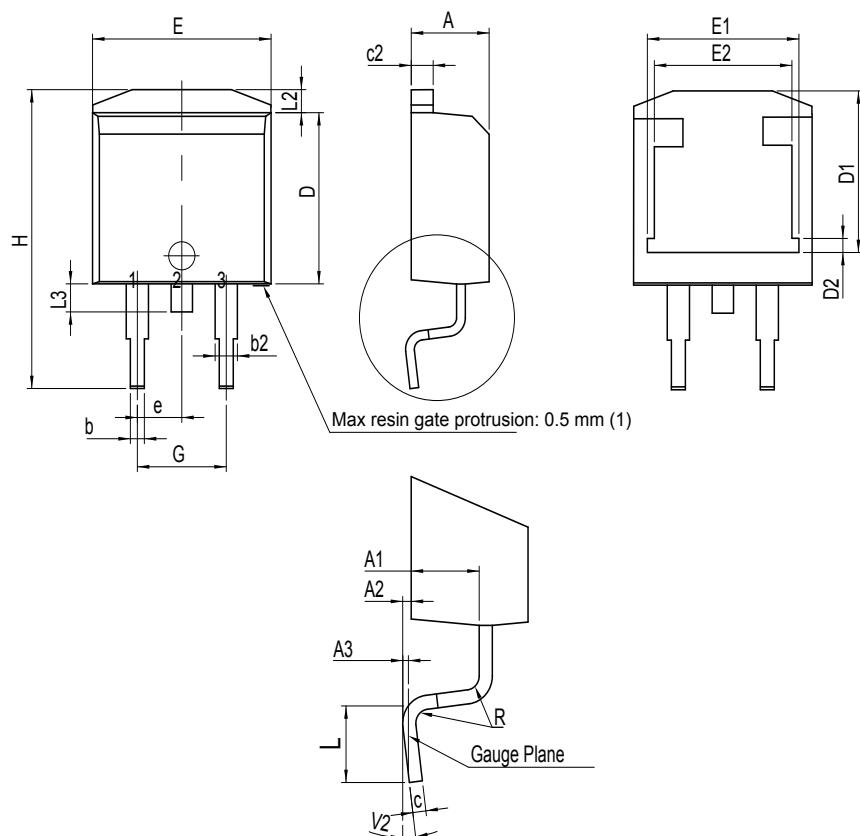
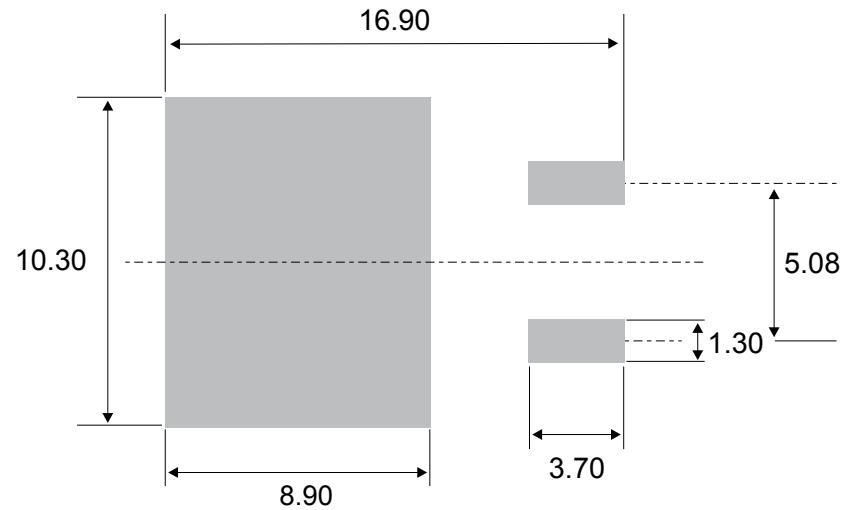
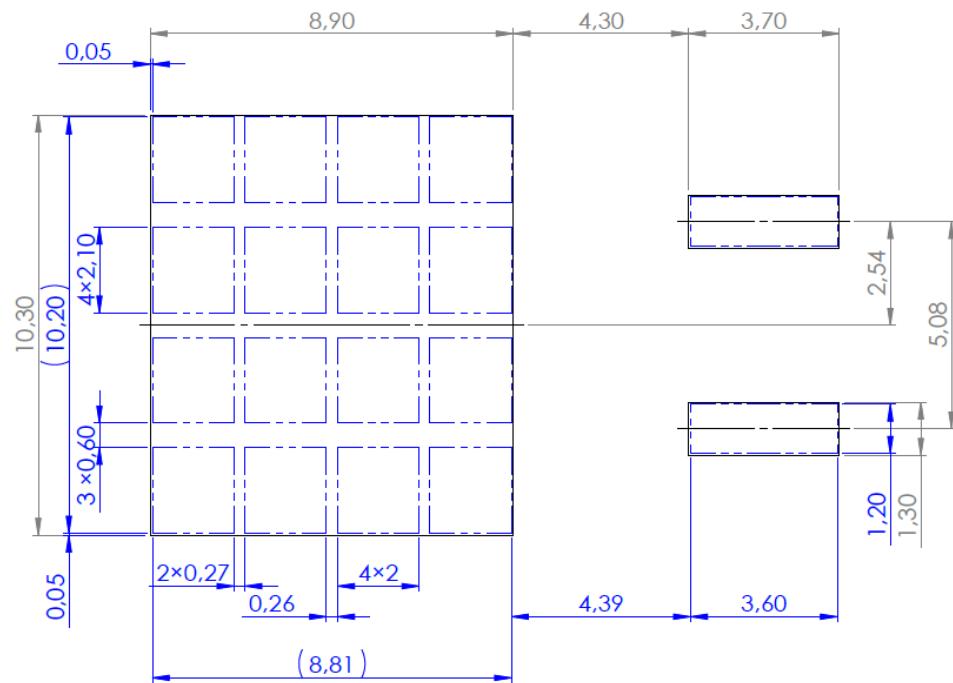


Table 5. D<sup>2</sup>PAK package mechanical data

Ref.	Dimensions					
	Millimeters			Inches <sup>(1)</sup>		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.30		4.60	0.1693		0.1811
A1	2.49		2.69	0.0980		0.1059
A2	0.03		0.23	0.0012		0.0091
A3		0.25			0.0098	
b	0.70		0.93	0.0276		0.0366
b2	1.25		1.7	0.0492		0.0669
c	0.45		0.60	0.0177		0.0236
c2	1.21		1.36	0.0476		0.0535
D	8.95		9.35	0.3524		0.3681
D1	7.50		8.00	0.2953		0.3150
D2	1.30		1.70	0.0512		0.0669
e		2.54			0.1	
E	10.00		10.28	0.3937		0.4047
E1	8.30		8.70	0.3268		0.3425
E2	6.85		7.25	0.2697		0.2854
G	4.88		5.28	0.1921		0.2079
H	15		15.85	0.5906		0.6240
L	1.78		2.28	0.0701		0.0898
L2	1.19		1.40	0.0468		0.0551
L3	1.40		1.75	0.0551		0.0689
R		0.40			0.0157	
V2 <sup>(2)</sup>	0°		8°	0°		8°

1. Dimensions in inches are given for reference only

2. Degrees

Figure 15. D<sup>2</sup>PAK recommended footprint (dimensions are in mm)Figure 16. D<sup>2</sup>PAK stencil definitions(dimensions are in mm)

### 3 Ordering information

Figure 17. Ordering information scheme

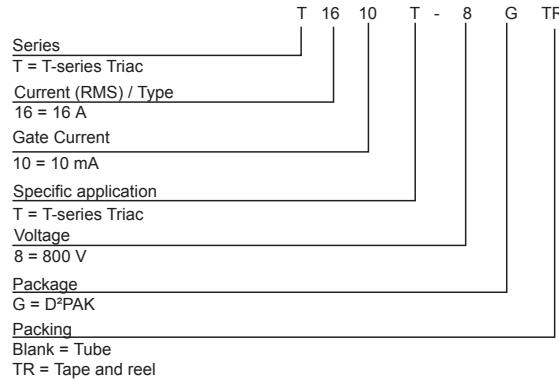


Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
T1610T-8G-TR	T1610T-8G	D <sup>2</sup> PAK	1.6 g	1000	Tape and reel
T1610T-8G				50	Tube

## Revision history

**Table 7. Document revision history**

Date	Version	Changes
03-Apr-2018	1	Initial release.
17-Jul-2018	2	Updated Table 2. Electrical characteristics ( $T_j = 25^\circ\text{C}$ , unless otherwise specified).
29-Oct-2020	3	Updated Table 5 and added Figure 13. Thermal resistance junction to ambient versus copper surface under tab. Minor text changes.

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